

Dynamic Characteristics

ARF460AG/BG

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
C_{iss}	Input Capacitance	$V_{GS} = 0V$ $V_{DS} = 150V$ $f = 1MHz$		1200	1400	pF
C_{oss}	Output Capacitance			150	180	
C_{rss}	Reverse Transfer Capacitance			60	75	
$t_{d(ON)}$	Turn-on Delay Time	$V_{GS} = 15V$ $V_{DD} = 0.5V_{DSS}$ $I_D = I_{D[Cont.]} @ 25^\circ C$ $R_G = 1.6\Omega$		7		ns
t_r	Rise Time			6		
$t_{d(off)}$	Turn-off Delay Time			20		
t_f	Fall Time			4.0	7	

Functional Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
G_{PS}	Common Source Amplifier Power Gain	$f = 40.68MHz$ $I_{dq} = 50mA$ $V_{DD} = 125V$ $P_{OUT} = 150W$	13	15		dB
η	Drain Efficiency		70	75		%
Ψ	Electrical Ruggedness VSWR 10:1		No Degradation in Output Power			

1. Pulse Test: Pulse width < 380 μs , Duty Cycle < 2%.

Microsemi reserves the right to change, without notice, the specifications and information contained herein.

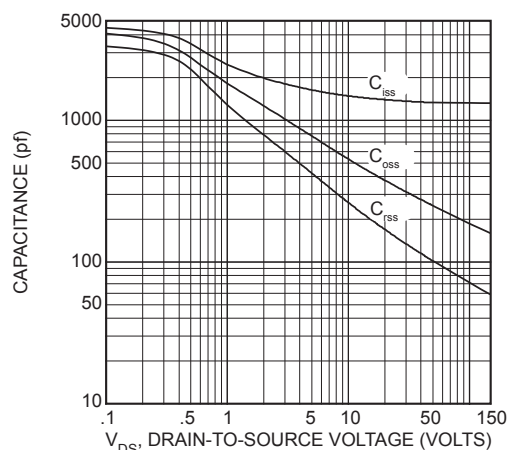


Figure 2, Typical Capacitance vs. Drain-to-Source Voltage

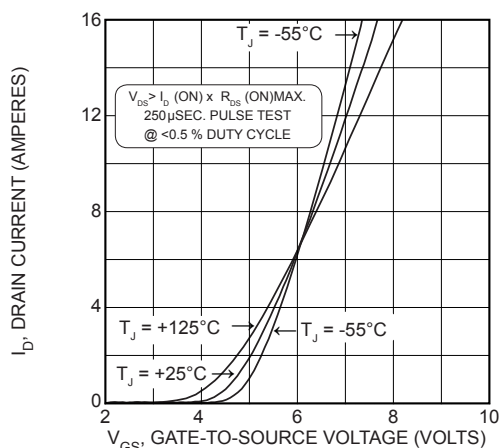


Figure 3, Typical Transfer Characteristics

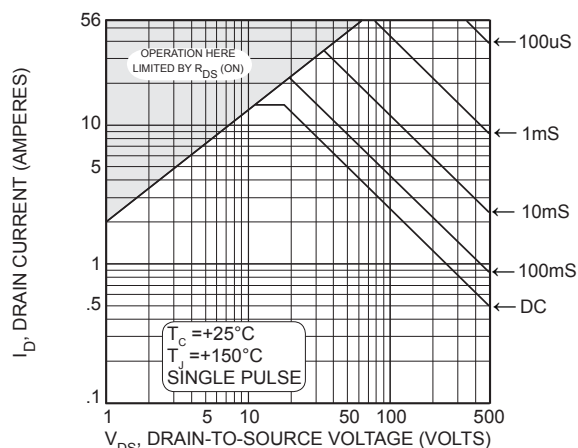


Figure 4, Typical Maximum Safe Operating Area

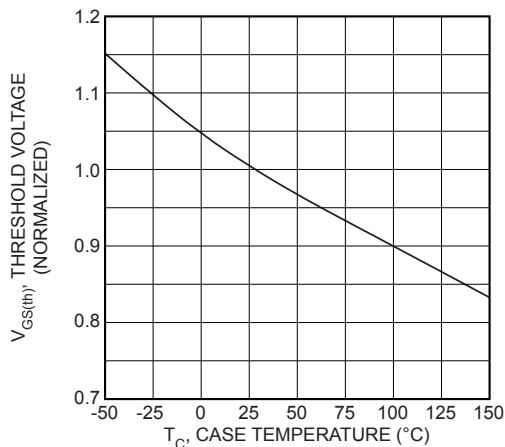


Figure 5, Typical Threshold Voltage vs Temperature

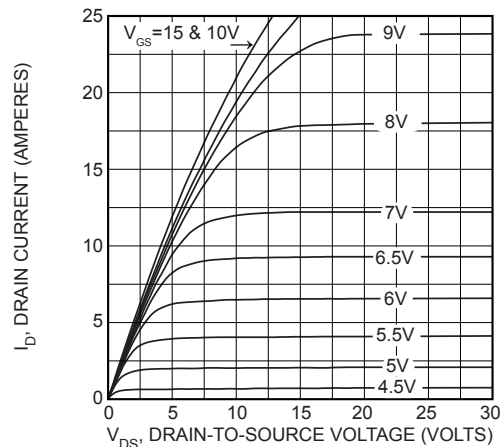


Figure 6, Typical Output Characteristics

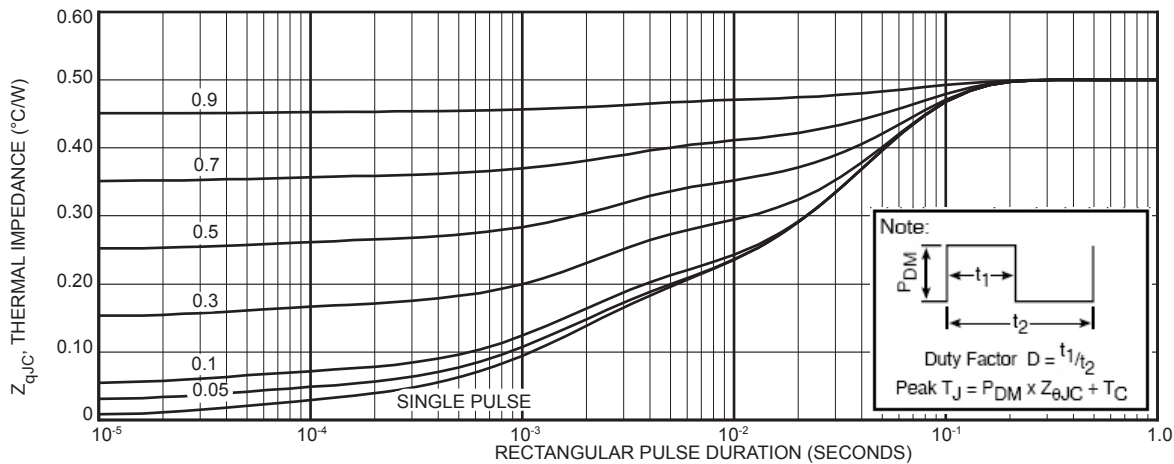


Figure 9, Typical Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration

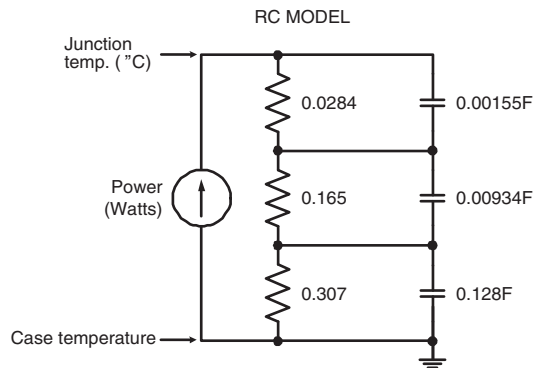
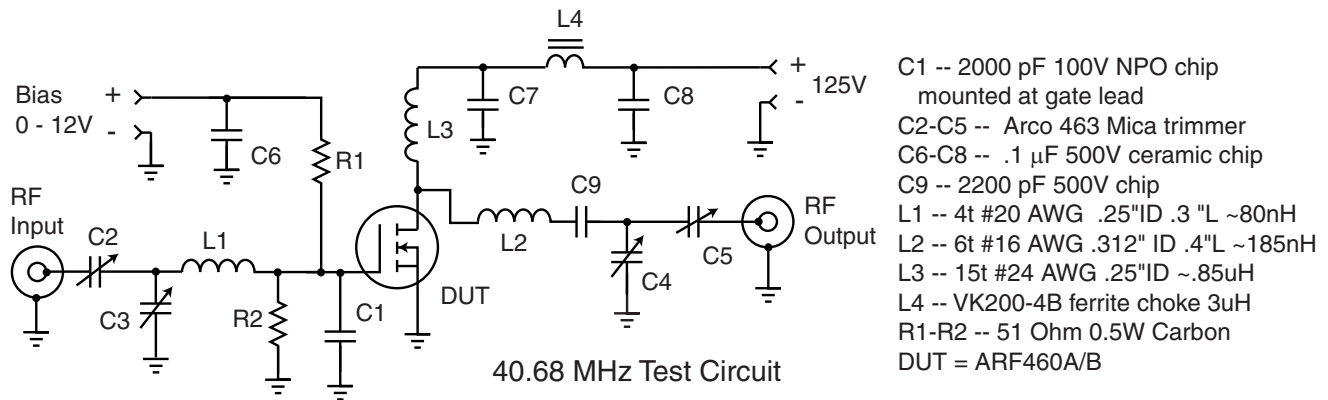


Figure 9a, TRANSIENT THERMAL IMPEDANCE MODEL

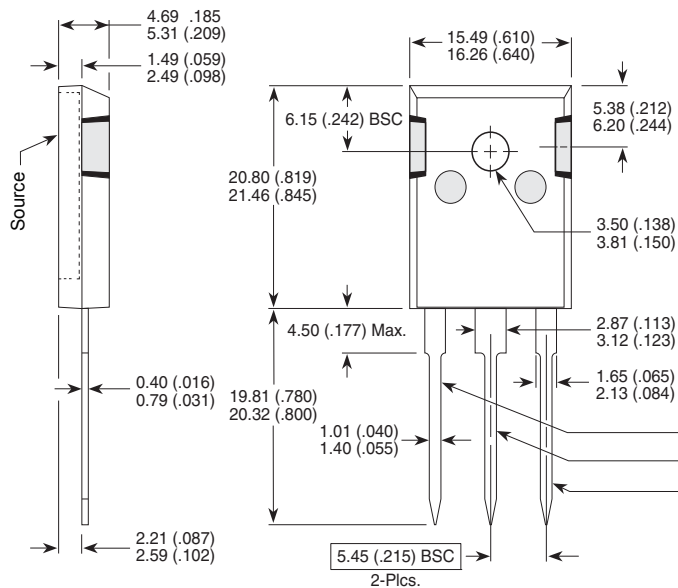
Table 1 - Typical Class AB Large Signal Input - Output Impedance

Freq. (MHz)	$Z_{in} (\Omega)$	$Z_{OL} (\Omega)$
2.0	20.9 - j 9.2	38 - j 2.6
13.5	2.4 - j 6.8	31 - j 14
27	.57 - j 2.6	19.6 - j 17.6
40	.31 - j 0.5	12.5 - j 15.8
65	.44 - j 1.9	6.0 - j 10.5

Z_{in} - Gate shunted with 25Ω $I_{dq} = 100mA$
 Z_{OL} - Conjugate of optimum load for 150 Watts output at $V_{dd} = 125V$



TO-247 Package Outline



NOTE: These two parts comprise a symmetric pair of RF power transistors and meet the same electrical specifications. The device pin-outs are the mirror image of each other to allow ease of use as a push-pull pair.

Device	
ARF- A	ARF- B

Gate ----- Drain
Source ---- Source
Drain ----- Gate

Dimensions in Millimeters and (Inches)